

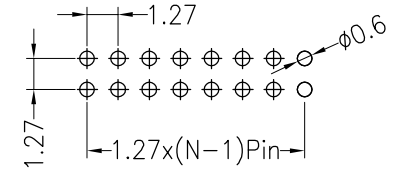
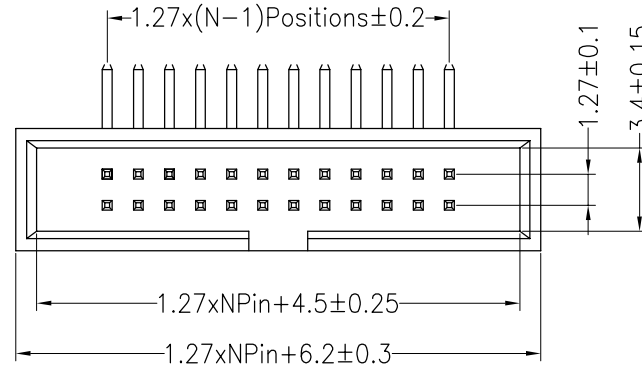


SPECIFICATIONS

Rated Current:1.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Brass
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PA6T
 Max.Processing Temp: 230°C for 30-60 seconds
 (260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

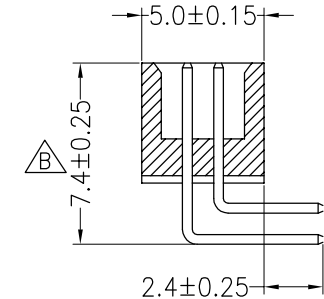
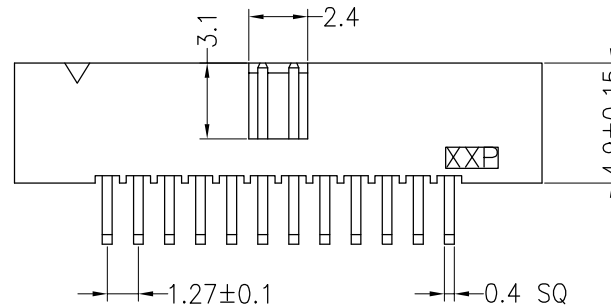
3230 XX R XX X B K00 X OX

No.of Pins
10-100P

Contact Plating
 G1:Gold Flash
 G2:1.5U" Gold
 G3:2U" Gold
 G4:3U" Gold
 G5:5U" Gold
 S0:Gold Flash/Tin
 SN:Tin

Insulator Material
 Option
 A=BK-PBT
 C=BK-PA6T
 D=BK-PA46
 E=BK-PA9T
 F=BK-LCP

Packing
 O=PE Bag
 A=Tray
 T=Tube
 P=Tube+Cap



				OPERATION		DRAW	Liu Miao	14.10.18	SCALE	FIT	WFD 深圳市旺富达电子有限公司 CONN SHEN ZHEN WFD ELECTRONICS CO., LTD	
				X.X	±0.30				UNIT	mm		
B	2014.10.18	change Height 7.7mm → 7.4mm		X.XX	±0.20	CHECK			SIZE	A4	PART NO.	3230XXRXXXBK00X0X
A0	2012.03.28	NEW DRAWING		X.XXX	±0.10	APPROVE			SHEET	1/1	TITLE:	1.27Box Header Npin H4.9 90°
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle	±3°		DIM	TOL	PROJ.			
1	2	3	4	5	6	7	8	9				